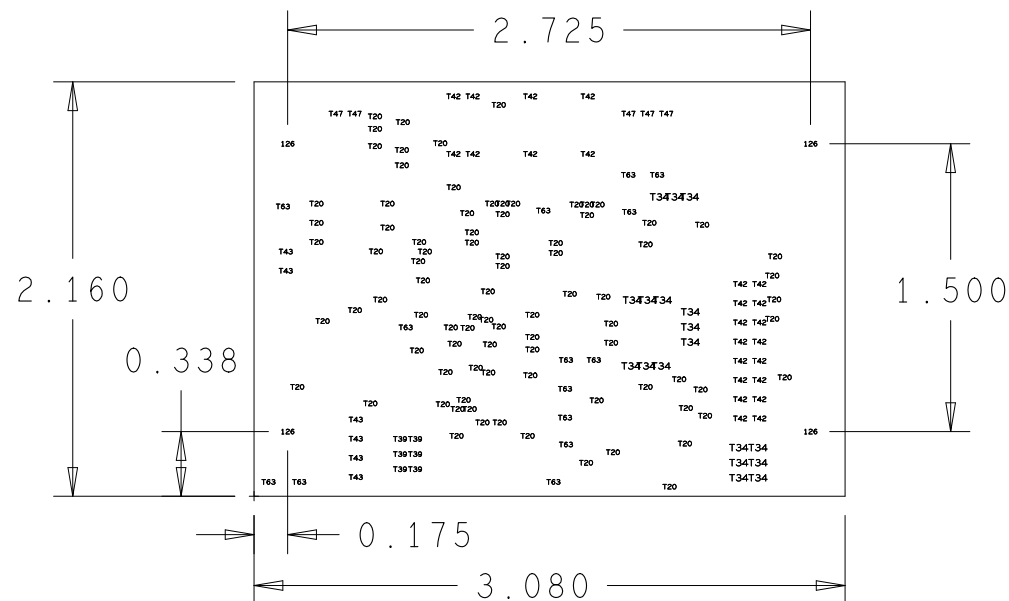
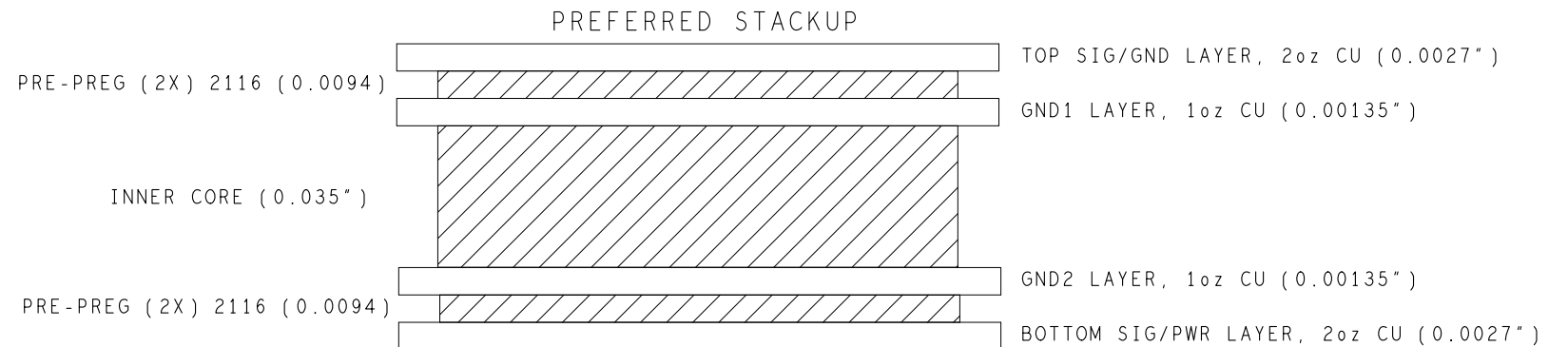


CLASS II FABRICATION NOTES: (UNLESS OTHERWISE SPECIFIED)

1. BOARDS SHALL BE 100% NET LIST TESTED FOR OPENS AND SHORTS PER PROVIDED IPC-D-356 NETLIST.
2. THIS BOARD SHALL BE MANUFACTURED IN ACCORDANCE WITH IPC-6012A CLASS II SPECIFICATIONS AND MEET IPC-600 CLASS II ACCEPTABILITY STANDARDS.
3. MATERIAL:
 - a. FR4 PER IPC 4101B/24 /26. OR /28.
 - b. SIGNAL LAYERS TO BE 2 OZ. COPPER.
 - c. PLANE LAYERS TO BE 1 OZ. COPPER.
 - d. OVERALL THICKNESS TO BE 0.062" +/- 0.007"
4. LEGEND:
 - a. WHITE NON-CONDUCTIVE EPOXY INK BOTH SIDES.
5. SOLDERMASK:
 - a. APPLY LIQUID PHOTO-IMAGABLE (LPI) SOLDER MASK OVER BARE COPPER PER IPC-SM-840 CLASS H, COLOR GREEN, BOTH SIDES.
6. PLATING FINISH:
 - a. HOT AIR SOLDER LEVELING (HASL) SN63A SnPb SOLDER.
 - ~~b. IMMERSION SILVER IAG.~~
7. PROCESS ALLOWANCES:
 - a. MAXIMUM BOW AND TWIST ACROSS DIAGONAL CORNERS OF THE BOARD SHALL NOT EXCEED 0.75%.
 - b. HOLE DIMENSIONS APPLY AFTER PLATING.
 - c. ALL HOLES SHALL BE LOCATED WITHIN 0.003" DIAMETER OF TRUE POSITION.
 - d. LAYER TO LAYER REGISTRATION SHALL BE WITHIN 0.003".
 - e. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/- 0.002".
 - f. REMOVE ALL BURRS AND BREAK SHARP EDGES 0/015" MAX.
 - g. CUT OUTSIDE OF 0.001" BOARD OUTLINE.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED



DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
T20	20.0	PLATED	86
T34	34.0	PLATED	18
T39	39.0	PLATED	6
T42	42.0	PLATED	24
T43	43.0	PLATED	6
T47	47.0	PLATED	5
T63	63.0	PLATED	14
T26	126.0	PLATED	4

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	SCPI CONTROL BOARD			
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS +/- 0.02" 3 PL DECIMALS +/- 0.005" ANGLES +/- 1 Degree FRACTIONS 1/16			MONTEREY BAY AQUARIUM RESEARCH INSTITUTE			
			7700 SANDHOLDT ROAD			
			MOSS LANDING, CA			
	DESIGNED BY: CHAD KEYC		SIZE B	REVISION A	DWG NO 10020902	
	LAYOUT BY: JOSE ROSAL		SCALE 1 - 1			SHEET 1 - 1